



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 10/055,298

Filed: January 23, 2002

For: METHOD AND APPARATUS FOR CONDUCTING HEAT IN A FLIP-CHIP

ASSEMBLY

Confirmation No.: 8949

Examiner: L. Thai

Group Art Unit: 2827

Attorney Docket No.: 2269-4376.1US

(99-0660.01/US)

Notice of Allowance Mailed:

May 19, 2004

CERTIFICATE OF MAILING

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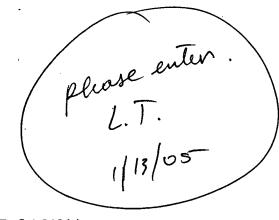
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Date

Signature

Deborah L. Hedricks

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AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

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Commissioner for Patents
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Sir:

Please amend the above-referenced application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 15 of this paper.